THE PROGRESS OF SBIR SUPPORTED R&D OF SOLID STATE PULSE MODULATORS*

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Abstract
The Small Business Innovative Research grant program funded by the US Department of Energy makes a number of awards each year for R&D in the field of accelerator technology including high power pulse modulators and their components. This paper outlines program requirements, and reviews some of the awards made in the last three years in support of high power modulator systems and solid state switching. A number of award recipients are presenting the results of their SBIR R&D at this workshop.

1. MECHANICS OF THE SMALL BUSINESS INNOVATIVE RESEARCH GRANT (SBIR) PROGRAM:

This section is a short summary of information available on the Office of Science, US Department of Energy web site located at http://sbir.er.doe.gov/sbir/. Each year, the DOE sets aside a portion of department funding to be awarded as grants to companies that qualify as small businesses in the USA. A small business as defined under this program is one that has less than 500 employees, is American owned, and is not part of a larger corporation.

There are three phases to the grant process. A Phase I grant can be for an amount of money up to $100,000 to initiate a new line of research, do limited experimental work to support the development proposal, and write a more extensive proposal for a Phase II award. Phase I solicitations are published on the DOE website in late November of each year, and grant proposals must be received in the DOE office by late February. Grant proposals are first checked by administrative staff for conformance to proposal submission requirements. Qualifying proposals are given an initial technical evaluation by DOE program administrators, and then sent to three independent reviewers chosen from the scientific community. Scores from these reviewers are tallied, and a listing is prepared for consideration by the program officer. Generally, the top scoring applications are chosen for grants. Middle scores are evaluated, and grants are given to those applications deemed most germane to the solicitation objectives. A well written proposal setting out clear technical goals directly addressing one of the solicitation objectives stands a very good chance of being funded.

Toward the end of the Phase I effort, if the Principal Investigator of the grant believes expanded R&D is justified, he writes a Phase II proposal which is submitted to the DOE about the end of March in the year following the SBIR Phase I award. It is expected that the Phase II effort is much more extensive with a prototype product emerging from the work. The term of a Phase II award is up to two years, and the maximum amount of the award is $750,000. An extensive report is due at the end of the grant, and in many cases, a completed product is delivered to one of the interested national laboratories.

In Phase III, it is intended that non-Federal capital be used by the small business concern to pursue commercial applications of the R&D. Also under Phase III, Federal agencies may award non-SBIR funded follow-on grants or contracts for products or processes that meet the mission needs of those agencies, or for further research or R&D.

Small business Technology Transfer Research (STTR) grants are also available. STTR is similar to the Small Business Innovation Research (SBIR) program in that both programs seek to increase the participation of small businesses in Federal R&D and to increase private sector...
commercialization of technology developed through Federal R&D. The unique feature of the STTR program is that, for both Phase I and Phase II projects, at least 40% of the work must be performed by the small business and at least 30% of the work must be performed by a non-profit research institution. Such institutions include federally funded research and development centers (for example, DOE national laboratories), universities, non-profit hospitals, and other non-profits.

2. **TOPIC HEADINGS GERMANE TO LINEAR ACCELERATOR TECHNOLOGY:**

2.1 Topic and Subtopic listings in each year’s SBIR Phase I solicitations are numerous, and are listed on the DOE web page. Those topics that cover high-energy physics in general, and klystron pulse modulators in particular are listed below along with a short solicitation description as published in the 2001 solicitation (italics).

5c. **New Concepts for Pulsed Power Modulator**

Most rf power sources for future linear colliders require high peak-power pulse modulators of considerably higher efficiency than presently available. Grant applications are sought for new types of modulators in the 400 kV - 1 MV range for driving currents of 400 - 800 A, with pulse lengths of 0.2 - 2 microseconds, and rise- and fall-times of less than 0.2 microsecond. Innovation related to cost saving, manufacturability, and electrical efficiency in modulators is especially important. Modulators with improved voltage control for rf phase stability in some alternate rf power systems are also sought.

Grant applications are also sought to develop high power solid state switches, either Insulated Gate Bipolar Transistors (IGBTs) or Thyristors, for pulse power switching. Requirements include the ability to switch high current pulses (2-5 kAmps) at voltage levels of 2 to 6 kV with switching times of less than 300 nsec. Construction and low inductance packaging techniques must be developed to allow current state-of-the-art chip designs to handle very high di/dt (20 kAmps/Ìs) at low duty cycle (<0.1%).

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7a. **Direct Current (DC) and Pulsed Power Supplies, Modulators and Components**

Advances are needed in various aspects of pulse modulators and associated components to drive klystrons in both injector and main linac applications. Grant applications are sought for:

(1) DC Power Supplies operating at 2 to 5 kV from about 50 to 500 kW output, to drive capacitor banks in IGBT (Insulated Gate Bipolar Transistor) switched induction modulators or Marx generators. The power supplies must have 0.1 percent regulation, withstand pulsed current duty cycle between short discharges (3 - 6 microseconds) and recharge at 120-180 Hz steady state. Operation for shorter pulses at higher recharge rates is also desired for testing purposes. Other objectives include high reliability, low cost, and efficiency greater than 90 percent.

(2) Ultra-Reliable Capacitors of ~10-25 microfarads at 2.5 to ~6 kV to provide stored energy for partial discharge, on-off switch modulator configurations. Requirements include low loss, low inductance, high power density to minimize volume, MTBF >100,000 hours, and low cost. Long lifetime is a priority because the large numbers of such units in the modulator designs will dominate modulator reliability.
(3) High Voltage Pulse Transformers with ratios from 1:6 up to 1:15, with low leakage inductance and minimized core loss, for use in solid-state-switch driven modulators with a load-matching transformer. The modulators will drive a pair of X-band klystrons at 180 Hz with ~500 kV, 520 A peak and 3 microseconds pulse-length, or drive an S-band klystron in the injector at 180 Hz with 380 kV, 800 A peak, and at least 6 (possibly up to 16) microseconds pulse-length. Rise/fall times of less than 300 ns and droop/ripple of less than 2 percent are desired. Transformers must operate in oil and be compact, efficient, and cost-effective to manufacture.

The whole listing can be found on the DOE SBIR website.

3. SOLID STATE PULSE SWITCHING TECHNOLOGY GRANTS:

There is currently work going on as a result of several Phase I and Phase II grants made in 1999 and 2000. Some of those pertaining to modulators are listed below.

North Star Research Corporation Phase I
Pulse-Step-Modulation Modulators
for Radio Frequency Accelerator Applications

Applied Pulse Power, Inc. Phase I
80 Kilovolts, High-Power, High di/dt, Low-Inductance, Solid State Switch

Diversified Technologies, Inc. Phase I
Next-Generation Linear Collider Buck Regulator Power Supply

Sigma Technologies International, Inc. Phase I
Ultra-Reliable Hybrid Film Capacitors

Diversified Technologies, Inc. Phase I
Solid-State Modulators for Heavy Ion Fusion Accelerators

Diversified Technologies, Inc. Phase II
New Concepts for Pulsed Power Modulators

Diversified Technologies, Inc. Phase II
Hybrid NCL Modulator

Diversified Technologies, Inc. Phase II
High Power Switch

As can be seen from the listing above, there are just a few companies involved in this area of research grants. Broader participation would be most welcome.

4. SOME RESULTS, AND PROJECTIONS FOR THE FUTURE:

All pulse modulators need some sort of energy storage to take continuous energy from the power lines and deliver it as a short pulse train to loads such as klystrons. Depending on how power switching is done, this entails pulse discharge capacitors anywhere from 2 kV to over 100 kV. This group of capacitors is further divided into those which are fully discharged or even voltage reversed each pulse (PFN or Blumlein modulators) and quasi-DC capacitors where the capacitor bank stores much more energy than is discharged each pulse, and an on-off switch gates the pulse energy. Fortunately, these quasi-DC capacitors store energy much more compactly than a true pulse capacitor, and are probably more reliable as well.
Over the last several SBIR cycles, a number of proposals have been funded to research exotic ways to produce high energy density, ultra-reliable energy storage capacitors, but to date, it seems that the old standard polypropylene film, oil impregnated capacitors with some design and packaging refinements are still best for high power pulse energy storage. This year, we have only one company, Sigma Technologies, International, Inc. doing SBIR I work on a new capacitor design.

Three other companies holding SBIR grants are working on various pulse switching systems using solid-state devices. SCR’s (Thyristors) were originally thought to be a suitable replacement for thyratrons in PFN type modulators, but that technology did not develop into a viable product when pulses were short, in the range of 1 to 5 useconds, and switching powers were very high. Some R&D systems worked well under normal operation, but in fault conditions such as a klystron cathode-anode arc, the SCR’s were destroyed. This year, a new company, PTS, is manufacturing a line of SCR’s optimized for fast pulse switching, and Applied Pulse Power, Inc. has an SBIR Phase I grant to explore an 80 kV, 6,000 amp switch stack using these new SCR’s. If this R&D effort is successful, there may be a solid state equivalent of a SLAC type thyratron (F-241, etc) in the near future.

SBIR R&D work using IGBT technology is being carried out at Diversified Electronics, Inc. and North Star Research Corp. An extensive R&D program is also underway by the Electronics & Software Engineering group at SLAC. North Star Research Corp. is developing IGBT switches for pulse power applications. Diversified Electronics has several SBIR Phase I and II grants aimed at developing very fast high power switching with IGBT’s and protecting them in various fast fault conditions. The work of these organizations work is separately reported on at this workshop.

The future of solid-state modulators looks bright, but there are several serious areas of concern for solid state switching. New SCR’s and some high power IGBT’s can be made to switch very fast. The general impedance level in which all of these devices work is very low, and the effects of very small stray inductances both internal to, and outside of the devices can lead to transient voltage spikes and parasitic resonance’s that have the potential to destroy the lower voltage input circuits of the devices. This is especially true under load arcing fault conditions. Intense effort is underway to solve these problems, but this entails liaison with device manufacturers and careful scrutiny of internal connection paths to minimize and balance path inductances.

Device heat dissipation is also an area of concern. When most of these high power devices are used in long pulse, or AC switching applications, there is time for conduction path spreading in junctions that minimize “on” junction impedance. In fast switching conditions, however, when all the energy is delivered in a few microseconds, the dissipation in junctions is critically dependent on how well most of the junction is turned on by the gating pulse. This is not easy to analyze without characterizing every detailed current path in the device. This partial turn-on effect sometimes looks like an inductance from outside the device, but unlike an inductance, the effect is dissipative and contributes to the heat build-up in the device. Device manufacturers are only now starting to work with pulse system designers to optimize high power solid-state switches for fast switching operation.

Another problem that must be addressed before solid-state modulators become viable for driving high power beam devices such as klystrons is the amount of energy such a modulator can deliver into a cathode-anode load arc. A standard PFN modulator with step-up pulse transformer has intrinsic energy limiting from two sources, the stray inductance of the pulse transformer, and the intrinsic current limiting of the PFN characteristic impedance. Operating history shows us that a single klystron on a conventional PFN modulator can withstand occasional load arcs without serious damage to the gun electrodes. We are currently collecting arc data on the operation of two klystrons on a conventional PFN modulator, but so far, we have no experimental operating results for one or more klystrons operating on an IGBT switched modulator that has very low driving impedance. Protecting expensive klystrons is a very high priority in the design of these solid-state modulator systems.

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